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Reissue of U.S. Patent No. 6,329,213 B1

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Practitioner's Docket No. MI40-369**

This is part of the application for a reissue patent filed herewith based on the original patent identified as follows:

Inventors: Mark E. Tuttle et al.

Patent Number: 6,329,213 B1

Date Patent Issued: December 11, 2001

Title of Invention: Methods for Forming Integrated Circuits within Substrates

To: Mail Stop Reissue  
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**AMENDMENT UNDER 37 C.F.R. §1.173(b)**